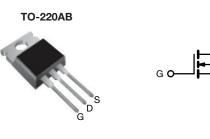
SiHP22N60E





E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.18			
Q _g max. (nC)	86			
Q _{gs} (nC)	11			
Q _{gd} (nC)	24			
Configuration	Single			



S N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP22N60E-E3			
Lead (Pb)-free and Halogen-free	SiHP22N60E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	V	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	21		
	V _{GS} at 10 V	T _C = 100 °C		13	А	
Pulsed Drain Current ^a			I _{DM}	56		
Linear Derating Factor				1.8	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	367	mJ	
Maximum Power Dissipation			PD	227	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	$T_J = 1$	125 °C	-l\//-lt	70		
Reverse Diode dV/dt d			dV/dt	11	V/ns	
Soldering Recommendations (Peak temperature) ^c for 10 s				300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 5.1 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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RoHS

COMPLIANT

HALOGEN



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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.55			°C/W			
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	-	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static	••••••	1						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	_	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$			l _D = 250 μA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D =	5	2	-	4	V
	• GS(III)	-	$V_{GS} = \pm 20$	-	-	_	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		_	_	± 100	μA
			$= 600 \text{ V}, \text{ V}_{c}$		_	_	1	- μA
Zero Gate Voltage Drain Current	I _{DSS}				-	_	10	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ $V_{GS} = 10 \text{ V} \qquad I_{D} = 11 \text{ A}$		-	0.15	0.18	Ω	
Forward Transconductance	g fs	V _D	_s = 8 V, I _D	= 5 A	-	6.4	-	S
Dynamic								
Input Capacitance	C _{iss}	$\label{eq:VGS} \begin{array}{c} V_{GS}=0 \ V, \\ V_{DS}=100 \ V, \\ f=1 \ MHz \end{array}$		-	1920	-	-	
Output Capacitance	C _{oss}			-	90	-		
Reverse Transfer Capacitance	C _{rss}			-	6	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	73	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	263	-	1	
Total Gate Charge	Qg				-	57	86	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 11 \text{ A}, V_{DS} = 480 \text{ V}$		-	11	-	nC	
Gate-Drain Charge	Q _{gd}				-	24	-	
Turn-On Delay Time	t _{d(on)}				-	18	36	
Rise Time	t _r	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 11 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ $\text{f} = 1 \text{ MHz, open drain}$		-	27	54	- ns	
Turn-Off Delay Time	t _{d(off)}			-	66	99		
Fall Time	t _f			-	35	70		
Gate Input Resistance	Rg			0.3	0.77	1.2	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21		
Pulsed Diode Forward Current	I _{SM}			-	-	56	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	v	
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	344	-	ns	
Reverse Recovery Charge	Q _{rr}			-	5.3	-	μC	
Reverse Recovery Current	I _{RRM}			-	28	_	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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SiHP22N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

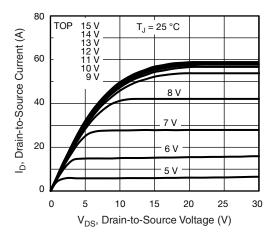


Fig. 1 - Typical Output Characteristics

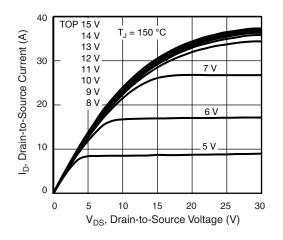


Fig. 2 - Typical Output Characteristics

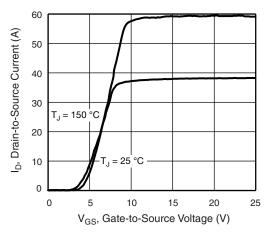


Fig. 3 - Typical Transfer Characteristics

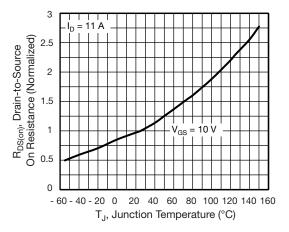


Fig. 4 - Normalized On-Resistance vs. Temperature

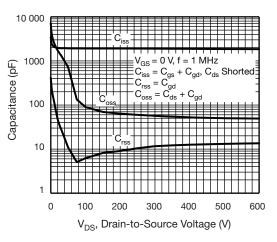


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

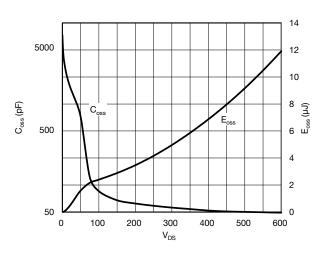


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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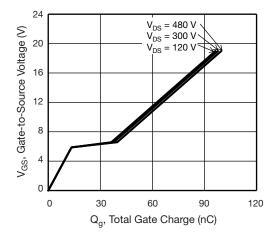


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

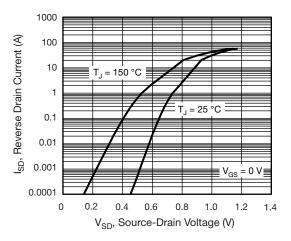


Fig. 8 - Typical Source-Drain Diode Forward Voltage

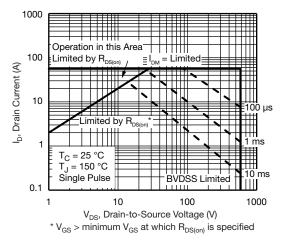


Fig. 9 - Maximum Safe Operating Area

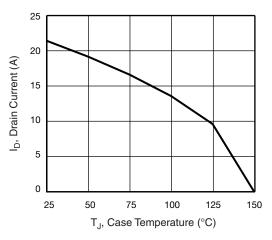


Fig. 10 - Maximum Drain Current vs. Case Temperature

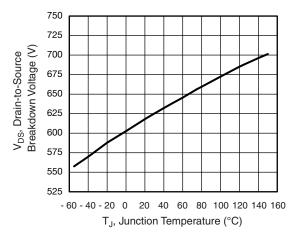
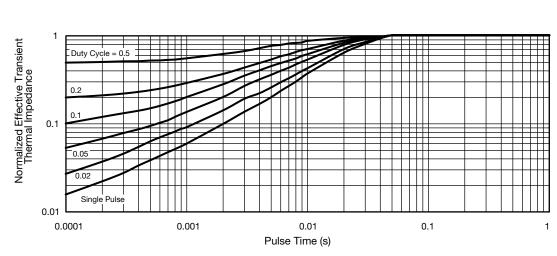
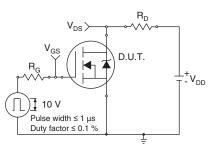


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

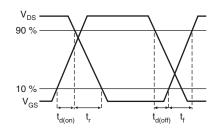


Fig. 14 - Switching Time Waveforms

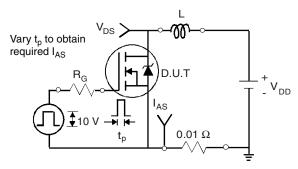


Fig. 15 - Unclamped Inductive Test Circuit

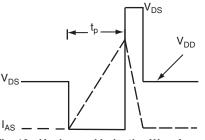


Fig. 16 - Unclamped Inductive Waveforms

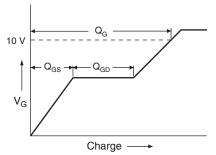


Fig. 17 - Basic Gate Charge Waveform

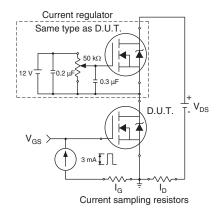


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

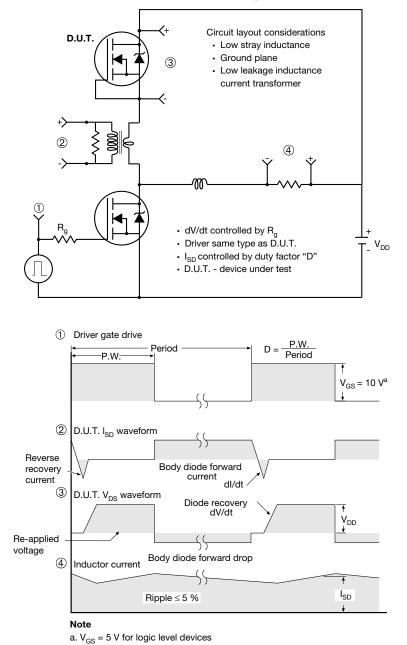


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

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